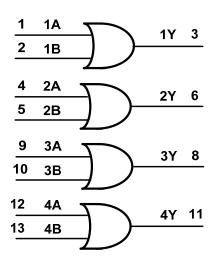


# **Pin Descriptions**

Pin Number	Pin Name	Function
1	1A	Data Input
2	1B	Data Input
3	1Y	Data Output
4	2A	Data Input
5	2B	Data Input
6	2Y	Data Output
7	GND	Ground
8	3Y	Data Output
9	3A	Data Input
10	3B	Data Input
11	4Y	Data Output
12	4A	Data Input
13	4B	Data Input
14	V <sub>CC</sub>	Supply Voltage

# **Logic Diagram**



# **Function Table**

Inp	Output	
Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н



# Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> < -0.5V or Vi > V <sub>CC</sub> +0.5V	±20	mA
l <sub>ok</sub>	Output Clamp Current $V_O < -0.5V$ or $V_O > V_{CC} +0.5V$	±20	mA
Io	Continuous Output Current -0.5V < V <sub>O</sub> V <sub>CC</sub> +0.5V	+/- 25	mA
Icc	Continuous Current Through Vcc	50	mA
I <sub>GND</sub>	Continuous Current Through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
P <sub>TOT</sub>	Total Power Dissipation	500	mW

Notes:

# Recommended Operating Conditions (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		4.5	5.5	V
VI	Input Voltage		0	$V_{CC}$	V
Vo	Output Voltage		0	$V_{CC}$	V
Δt/ΔV	Input Transition Rise or Fall Rate	V <sub>CC</sub> = 4.5V to 5.5V		500	ns/V
T <sub>A</sub>	Operating Free-Air Temperature		-40	+125	°C

Note: 6. Unused inputs should be held at V<sub>CC</sub> or Ground.

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

0	D	To al O an dilliana	.,	T <sub>A</sub> = -40°C to +85°C		T <sub>A</sub> = -40°C to +125°C		1114
Symbol	Parameter	Test Conditions	Vcc	Min	Max	Min	Max	Unit
V <sub>IH</sub>	High-level Input Voltage		4.5V to 5.5V	2.0		2.0		V
V <sub>IL</sub>	Low-level Input Voltage		4.5V to 5.5V		0.8		0.8	V
.,	High-level Output	I <sub>OH</sub> = -20μA	4.5V	4.4		4.4		V
VOH	V <sub>OH</sub> Voltage	I <sub>OH</sub> = -4mA	4.5V	3.80		3.70		V
Vol	Low-level Output	I <sub>OL</sub> = 20μA	4.5V		0.1		0.1	V
VOL	Voltage	I <sub>OL</sub> = 4mA	4.5V		0.33		0.4	
l <sub>l</sub>	Input Current	V <sub>I</sub> =GND to 6.0V	6.0V		± 1		± 1	μΑ
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O = 0$	6.0V		20		40	μΑ
ΔI <sub>CC</sub>	Additional Supply Current	One input at V <sub>CC</sub> –2.1V Other pins at V <sub>CC</sub> or GND	4.5V to 5.5V		675		735	μΑ

<sup>4.</sup> Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

<sup>5.</sup> Input Voltage cannot exceed  $V_{\text{CC}}$  to the extent the Maximum clamp current is exceeded.



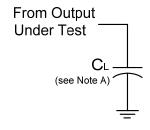
# **Switching Characteristics**

Comple al	Danamatan	Test	V	7	Γ <sub>A</sub> = +25°(	3	-40°C to +85°C	-40°C to +125°C	l locit
Symbol	Parameter	Conditions	V <sub>CC</sub>	Min	Тур	Max	Max	Max	Unit
t <sub>PD</sub>	Propagation Delay A <sub>N</sub> to Y <sub>N</sub>	Figure 1 C <sub>L</sub> = 50pF	4.5V	_	11	24	30	36	ns
t <sub>t</sub>	Transition Time	Figure 1 $C_L = 50pF$	4.5V	_	7	15	19	22	ns

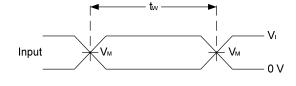
## Operating Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V <sub>CC</sub> = 5.5 V	Unit
			Тур	
C <sub>pd</sub>	Power Dissipation	f = 1 MHz	28	pF
Ора	Capacitance per Gate	1 - 1 1011 12	20	ρι
Cı	Input Capacitance	$V_I = V_{CC} - \text{ or GND}$	4	pF

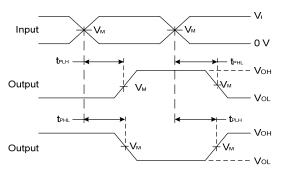
## **Parameter Measurement Information**



Vcc	Inp	outs	V <sub>M</sub>	Cı	
VCC	VI	$V_1$ $t_r/t_f$	V M	OL.	
4.5V	3.0V	3ns	1.5V	V <sub>OH</sub> /2	



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

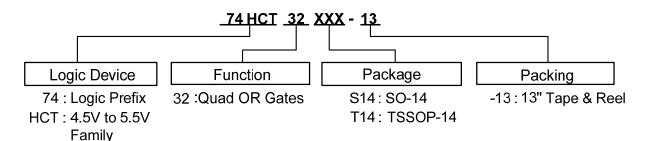
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.
- C. Inputs are measured separately one transition per measurement.
- D.  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$  are the same as  $t_{\text{PD}}.$

Figure 1 Load Circuit and Voltage Waveforms



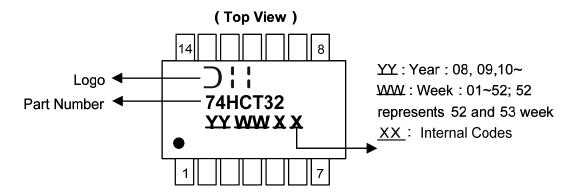
# **Ordering Information**



	Part Number Package Code		Dookoging	7" Tape and Reel		
	Part Number	Package Code	Packaging	Quantity	Part Number Suffix	
Lead-free Green	74HCT32S14-13	S14	SO-14	2500/Tape & Reel	-13	
Pb Lead-free Green	74HCT32T14-13	T14	TSSOP-14	2500/Tape & Reel	-13	

## **Marking Information**

(1) SO-14, TSSOP-14



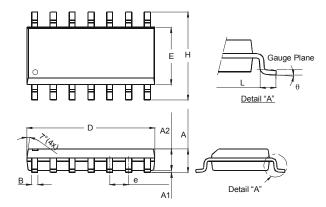
Part Number	Package
74HCT32S14	SO-14
74HCT32T14	TSSOP-14



# Package Outline Dimensions (All dimensions in mm.)

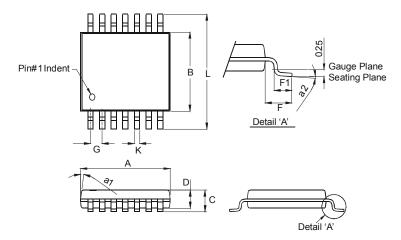
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

### Package Type: SO-14



SO-14					
Dim	Min	Max			
Α	1.47	1.73			
<b>A</b> 1	0.10	0.25			
A2	1.45 Typ				
В	0.33	0.51			
D	8.53	8.74			
Е	3.80	3.99			
е	1.27	Тур			
Н	5.80	6.20			
L	0.38	1.27			
θ	0°	8°			
All Di	All Dimensions in mm				

## Package Type: TSSOP-14



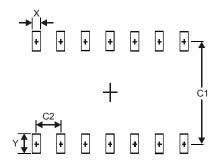
-	TSSOP-14					
Dim	Min	Max				
a1	7° (	4X)				
a2	0°	8°				
Α	4.9	5.10				
В	4.30	4.50				
O		1.2				
D	8.0	1.05				
F	1.00	Тур				
F1	0.45	0.75				
G	0.65 Typ					
K	0.19	0.30				
<b>L</b> 6.40 Typ						
All Din	nensions	s in mm				



# **Suggested Pad Layout**

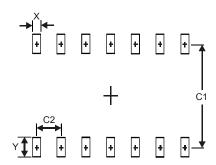
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

## Package Type: SO-14



<b>Dimensions</b>	Value (in mm)
X	0.60
Y	1.50
C1	5.4
C2	1.27

### Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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